

Research and Development Projects

Circuit Center Inc has a very active R&D program dedicated to developing and extending frontiers of electronics assembly and test technologies.

Below is a sample of current and recent R&D projects performed by the team of our R&D engineers and technicians. Please call for further details on the projects.

- *Development of a novel technique in the use of IR imaging in debug*
- *Failure analysis of Resnet defects in lead free processes*
- *Testing DDR socket continuity using JTAG boundary scan*
- *Reliability of imbedded pin packages*
- *DFM investigation of PoP package assemblies*